IPC ASSOCIATION ELECTRONICS	Material Comp © Copyright 2005. international and Pa	IPC, Bannockl	ourn, Illinois. A	All rights reserved untions.		ment is a de	claration ation end	n of the sub compasses	bstances all lower	within the manufa level materials fo	cturer listed r which the	l item. Note: manufactur	if the item is an a er has engineering	ssembly with lov responsibility.	
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials ar					terials and	Mfg Informa	ation		
upplier	Information														
Company n	ame*		Company unique ID			Unique II	Unique ID Authority					Response Date*			
nsemi												2023-06-08			
Contact Na	me	·	Title - Contact			Phone - C	Phone - Contact*				Email	Email - Contact*			
Product-Er	nv-Stewards		Product Enviro Compliance			NA	NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative*				Title - Representative			Phone - Representative*				Email	Email - Representative*			
roduct-Eı	nv-Stewards		Product Enviro Compliance			NA	NA				Produ	Product-Env-Stewards@onsemi.com			
	Requester Item Number	LV8104V-TLM-H 3PH PRE SEN pre-driver with		Mfr Item Name		Effective	e Date	Version	sion Manufacturing Site			Weight*	UOM	Unit Type	
					OR CLOSE; Three phase all sensor method (closed ol)	2023-06	2023-06-08 PHM			350.0	mg	Each			
Ianufact	turing Proccess Informa	ation													
Т	Terminal Plating / Grid Array Material		Terminal Base Alloy J-S		J-STD-020 MSL Rating	Peal	Peak Process Body		Temperature Max Time at Peak		eak Temper	ature Nun	nber of Reflow Cy	cles	
c	contains Bi		CU Alloy 3		3	260	260 C 30		30	seconds 3					
omments															
<b>CTENTIC</b>	ON: MSL 3 Rated item requir	es Bake and <b>D</b>	ry Pack (afte	r electrical test)											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.82	mg	Supplier	Silicon (Si)	7440-21-3		3.8059	mg
			Supplier	Polyimide	Proprietary Data		0.0141	mg
Die Attach	0.95	mg	Supplier	Silver (Ag)	7440-22-4		0.6464	mg
			Supplier	Epoxy resins	129915-35-1		0.2747	mg
			Supplier	Other Metal Oxide	Proprietary Data		0.0207	mg
			В	Antimony Pentoxide (Sb2O5)	1314-60-9		0.0082	mg
Lead Frame	123.4	mg	Supplier	Silver (Ag)	7440-22-4		0.3949	mg
			Supplier	Zinc (Zn)	7440-66-6		0.2345	mg
			Supplier	Iron (Fe)	7439-89-6		3.1961	mg
			Supplier	Copper (Cu)	7440-50-8		119.4018	mg
			Supplier	Phosphorus (P)	7723-14-0		0.1728	mg
Mold Compound-Black	217.08	mg		Epoxy Phenol Resin	proprietary data		26.0496	mg
			Supplier	Carbon Black (C)	1333-86-4		0.8683	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		183.6497	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		6.5124	mg
Plating	3.85	mg	В	Bismuth (Bi)	7440-69-9		0.0231	mg
			Supplier	Tin (Sn)	7440-31-5		3.8269	mg
Wire Bond - Au	0.9	mg	Supplier	Gold (Au)	7440-57-5		0.9	mg